

Quartet Embedded Solutions for TX2

High-Performance TX2 Carrier Board for Embedded Vision **TX2 Module 4 GB / 8GB**

Quartet Carrier Board for TX2 enables easy integration of up to 4 x USB3 machine vision cameras at full bandwidth. The Nvidia Jetson deep learning hardware accelerator allows for a complete decision-making system on a single compact board. This custom carrier board provides a fully integrated SOM design which optimizes size and cost by eliminating the need for peripheral hardware and host systems.

APPLICATIONS

ADAS 3D SCANNING METROLOGY ROBOTICS AGVS P&P / SMT MACHINES SELF-GUIDED ROBOTS UAVS

A CONTRACTOR OF CONTRACTOR OF

TURNKEY SOLUTION: RUN UP TO 4 CAMERAS SIMULTANEOUSLY

With its 4x USB3 TF38 connectors, the NVIDIA Jetson TX2 module and pre-integrated Spinnaker SDK, the Quartet enables integration of up to four machine vision cameras simultaneously running in a single system.

REDUCE SYSTEM FOOTPRINT

Fully integrated SOM design eliminating the need for peripheral hardware and host systems. It combines power and data transmission over a single cable for a remarkably compact footprint, allowing integrators to easily integrate a powerful single board computer (SBC) into space constrained vision systems.

POWERFUL AND FLEXIBLE HARDWARE

Three system options available depending on your needs. Two options with the module pre-installed with the Spinnaker SDK, enabling plug and play compatibility with Blackfly S USB3 board level cameras. Or the option to buy only the carrier board and build your own system.

www.teledyneflir.com

Imagery for illustration purposes only. Specifications are subject to change without notice. ©2021 Teledyne FLIR LLC, Inc. All rights reserved. 11/08/2021 REV1



SPECIFICATIONS	ACC-01-6003	ACC-01-6004	ACC-01-6005	
Memory	N/A	4 GB 128-bit LPDDR4 51.2 GB/s	8 GB 128-bit LPDDR4 51.2GB/s	
CPU	N/A	Dual-Core NVIDIA Denver 1.5 64-Bit CPU and Quad-Core ARM® Cortex®-A57 MPCore processor		
Display	HDMI Type A x 1			
GPU	N/A	256-core NVIDIA Pascal™ GPU architecture with 256 NVIDIA CUDA cores		
Storage	N/A	32 GB eMMC 5.1	16 GB eMMC 5.1	
Expansion	SATA connector x1 Fan connector x1			
Dimensions	138 mm × 92 mm × 18.2 mm			
Mass	95 g	182 g		
Operating Temperature	-4°F - 140°F (-20°C - 60°C)* w/0.5 m/s air-flow			
Storage Temperature	-40°F - 158°F (-40°C - 70°C)			
Storage Humidity	5 - 95% @ 40°C, non-condensing			
Input Power	10~24 Vdc with 2-pin terminal block			
Input Output	USB 3.0 x 4 (TF-38) USB 2.0 type A x 1 USB 3.0 type A x 1 Power switch x 1 with LED Micro SD slot x 1 OTG x 1			
Module Power	N/A	7.5 W ,	7.5 W / 15 W	
Operating System	N/A	Arch Linux		

TELEDYNE FLIR

CANADA

12051 Riverside Way Richmond, BC, Canada V6W 1K7 T: +1 866.765.0827 (toll free) T: +1 604.242.9937 F: +1 604.242.9938 E: mv-sales@teledyneflir.com www.flir.com/mv USA T: +1 866.765.0827 (toll free) E: mv-na-sales@teledyneflir.com

CHINA T: +86 10 8215 9938 F: +86 10 8215 9936 E: MV-chinamainlandsales@teledyneflir.com ASIA E: mv-asiasales@teledyneflir.com

EUROPE T: +49 7141 488817-0 F: +49 7141 488817-99 E: mv-eusales@teledyneflir.com

For More Information contact: mv-sales@teledyneflir.com I +1 866.765.0827 www.flir.com/products/quartet-embedded-solution-for-tx2

www.teledyneflir.com

Imagery for illustration purposes only. Specifications are subject to change without notice. @2021 Teledyne FLIR LLC, Inc. All rights reserved. 11/08/2021 REV1